

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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## **Customer Notification**

# **QB-78K0LX2™**

## **In-Circuit Emulator**

## **Operating Precautions**

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### **Target devices**

**78K0/LE2**

**78K0/LF2**

**78K0/LG2**

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QB-78K0LX2

**(A) Table of Operating Precautions**

No.	Outline	Control Code <small>Notes 1, 2</small>	QB-78K0LX2		
			A	B	
1	Caution on LCD voltage, when using internal voltage booster (Technical Limitation)		X	✓	
2	Caution on target voltage during break (Direction of use)		X	X	
3	Support of specification change for option byte (Technical Limitation)		X	✓	
4	Caution on power-on-clear function (Direction of use)		X	X	

- ✓ : Not applicable  
 X : applicable

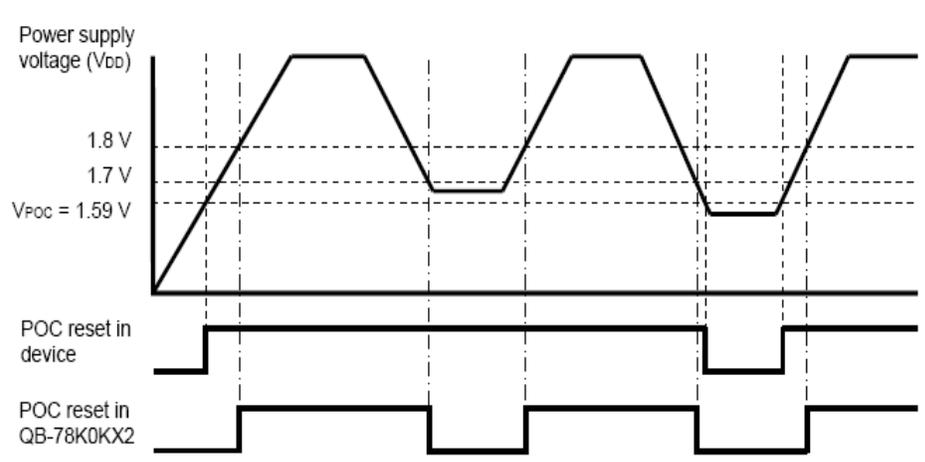
**Notes:**

1. The “control code” is the second digit from the left in the 10-digit serial number in the warranty supplied with the product you purchased (if it has not been upgraded). If the product has been upgraded, a label indicating the new version is attached to the product and the x in V-UP LEVEL x on this label indicates the control code.
2. Form control code “B” onwards a realchip (uPD78F0547 V2.0) is used.

**Caution: Pls. refer to and consider the Operating Precautions mentioned in the Customer Notifications of the according devices, to which this Emulator belongs to.**

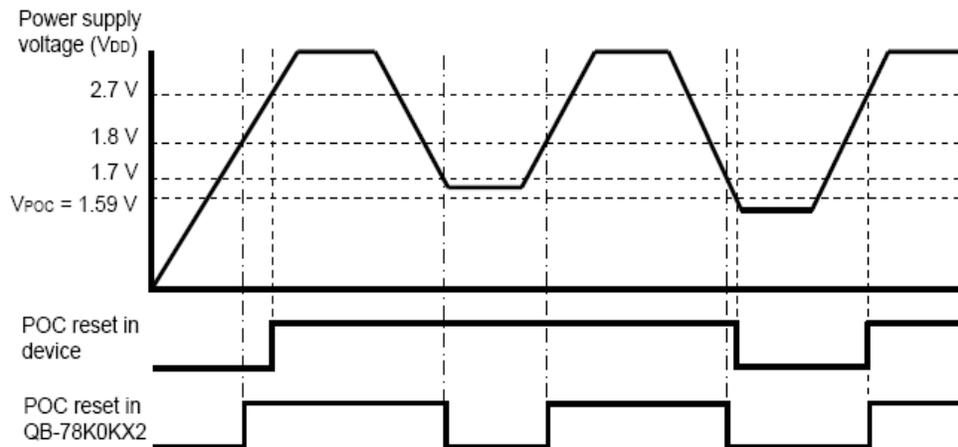
**(B) Description of Operating Precautions**

No. 1	Caution on LCD voltage, when using internal voltage booster (Technical Limitation)
	When the internal voltage booster of the LCD function is used (VLCON = 1), a LCD drive voltage ( $V_{LC0}, V_{LC1}, V_{LC2}$ ) is approximately 20% lower than the typical value. This behavior will be corrected in the next version.
No. 2	Caution on target voltage during break
	Do not decrease the target voltage during a break. If a reset by LVI or POC occurs during a break, the debugger operation may become illegal or a communication error may occur.
No. 3	Support of specification change for option byte (Technical Limitation)
	<u>Details</u> The POC mode (POCMODE) of the option byte is available in control code B or later. Please refer also to item No. 4 "Caution on power-on-clear function."

No. 4	Caution on power-on-clear function (Direction of use)
<p><u>Details</u> The POC detection voltage differs between the QB-78K0LX2 and the device.</p> <p><b>1. In 1.59 V POC mode (option byte: POCMODE = 0)</b></p> <ul style="list-style-type: none"> <li>• Device: An internal reset signal is generated at power application, and the reset state is released when the power supply voltage (<math>V_{DD}</math>) exceeds the detection voltage (<math>V_{POC} = 1.59\text{ V} \pm 0.15\text{ V}</math>). The power supply voltage (<math>V_{DD}</math>) and detection voltage (<math>V_{POC} = 1.59\text{ V} \pm 0.15\text{ V}</math>) are compared, an internal reset signal is generated when <math>V_{DD}</math> drops lower than <math>V_{POC}</math> (<math>V_{DD} &lt; V_{POC}</math>), and the reset state is released when <math>V_{DD}</math> becomes <math>V_{POC}</math> or higher (<math>V_{DD} \geq V_{POC}</math>).</li> <li>• QB-78K0LX2: An internal reset signal is generated at power application, and the reset state is released when the power supply voltage (<math>V_{DD}</math>) exceeds 1.80 V. An internal reset signal is generated when <math>V_{DD}</math> drops lower than 1.70 V (<math>V_{DD} &lt; 1.70\text{ V}</math>), and the reset state is released when <math>V_{DD}</math> becomes 1.80 V or higher (<math>V_{DD} \geq 1.80\text{ V}</math>).</li> </ul> 	

**2. In 2.7 V/1.59 V POC mode (option byte: POCMODE = 1)**

- Device: An internal reset signal is generated at power application, and the reset state is released when the power supply voltage ( $V_{DD}$ ) exceeds  $V_{POC}$  (power detection voltage at power application;  $V_{POC} = 2.7\text{ V} \pm 0.2\text{ V}$ ).  
The power supply voltage ( $V_{DD}$ ) and detection voltage ( $V_{POC} = 1.59\text{ V} \pm 0.15\text{ V}$ ) are compared, an internal reset signal is generated when  $V_{DD}$  drops lower than  $V_{POC}$  ( $V_{DD} < V_{POC}$ ), and the reset state is released when  $V_{DD}$  becomes 2.7 V or higher ( $V_{DD} \geq 2.7\text{ V}$ ).
- QB-78K0LX2: An internal reset signal is generated at power application, and the reset state is released when the power supply voltage ( $V_{DD}$ ) exceeds 1.80 V.  
An internal reset signal is generated when the detection voltage ( $V_{POC} = 1.59\text{ V} \pm 0.15\text{ V}$ )  $< V_{DD} < 1.70\text{ V}$ , and the reset state is released when  $V_{DD}$  becomes 1.80 V or higher ( $V_{DD} \geq 1.80\text{ V}$ ).  
If the power supply voltage ( $V_{DD}$ ) drops to a level of the detection voltage ( $V_{POC} = 1.59\text{ V} \pm 0.15\text{ V}$ ), the reset state is released the next time the power supply voltage ( $V_{DD}$ ) exceeds  $V_{POC}$  (power detection voltage at power application;  $V_{POC} = 2.7\text{ V} \pm 0.2\text{ V}$ ).



**(C) Valid Specification**

<b>Item</b>	<b>Date published</b>	<b>Document No.</b>	<b>Document Title</b>
1	March, 2005 or later	U17468EJ	User's Manual

**(D) Revision History**

<b>Item</b>	<b>Date published</b>	<b>Document No.</b>	<b>Comment</b>
1	June 28, 2004	TPS-LE-OP-TQBLX2-1	1 <sup>st</sup> Release
2	March 2006	TPS-LE-OP-TQBLX2-2	2 <sup>nd</sup> Release new control code